Light Sensor (AMS3)

Photo IC type high sensitive light sensor N a P i C a

Discontinued products Last time buy : 2017/12/31 Through-hole type

Features

- Built-in optical filter : visibility characteristics close to human visibility
- Liner photocurrent output proportionating to the brightness of surrounding environment
- Environmentally-friendly silicon chip
- RoHS compliant

Typical Applications

- Automatic lighting of lighting apparatus (domestic lighting, security light)
- Day and night power saving operation of domestic appliances
- Brightness detection of wall clocks (radio clocks)

Types

Dhotoourront	Part No.			
FIIOLOCUITEIIL	Tape and reel package Baggage package			
260 µA*	AMS302T	AMS302		
	Photocurrent	Photocurrent Tape and reel package		

Note: *Ev = 100 lx (Ev : Brightness, Fluorescent lamp is used as light source)

Ratings

• Absolute maximum ratings (Measuring condition: ambient temperature: 25 °C 77 °F)

Item	Symbol	Absolute maximum ratings	Remarks
Reverse voltage	VR	-0.5 V.DC to 8 V.DC	-
Photocurrent	ΙL	5 mA	-
Power dissipation	Р	40 mW	-
Operating temperature	Topr	–30 °C to 85 °C –22 °F to +185 °F	Non-condensing at low temperatures
Storage temperature	Tstg	–40 °C to 100 °C –40 °F to +212 °F	Non-condensing at low temperatures

Recommended operating condition

Item		Symbol	AMS302	Remarks
Reverse voltage	Minimum	VR	1.5 V.DC	-
	Maximum		6 V.DC	-

• Electrical and optical characteristics (Measuring condition: ambient temperature: 25 °C 77 °F)

	Item		Symbol	AMS302	Condition
Peak sensitivity v	vavelength	-	$\lambda_{ m p}$	580 nm	-
		Minimum		9.1 µA	
Photocurrent	otocurrent 1 Typical		I_{L1}	13 µA	$V_R=5$ V.DC, $E_v=5$ Ix *1
		Maximum		16.9 µA	
		Minimum		182 µA	
		Typical	I_{L2}	260 µA	V_R =5 V.DC, E_v =100 lx * ²
		Maximum		338 µA	
Photocurrent	3	Typical	I _{L3}	500 µA	V _R =5 V.DC, E _v =100 lx * ²
Dark current		Maximum	Ι _D	0.3 μΑ	$V_R=5$ V.DC, $E_v=0$ lx
Switching	Rise time	Typical	tr	8.5 ms	V_{cc} =5.0 V.DC, V ₀ =2.5 V.DC, R _L =5 k Ω
time	Fall time	Typical	t _f	8.5 ms	$V_{cc}=5.0$ V.DC, $V_0=2.5$ V.DC, $H_L=5$ KM

Note : *1 Fluorescent lamp is used as light source. Ev = Brightness

AMS302

*2 CIE standard illuminant 'A' is used as light source

[Measuring method for switching time]





Reference Data

50

45

40 35

30

25

20

15

10

20

Power dissipation (mW)

1. Power dissipation vs. ambient temperature characteristics





 Photocurrent vs. brightness characteristics Light source : Fluorescent lamp Reverse voltage : 5 V.DC Ambient temperature : 25 °C 77 °F

40

60

Ambient temperature (°C)

80

100



 Relative photocurrent vs. ambient temperature characteristics Light source : Fluorescent lamp, Brightness : 100 lx Reverse voltage : 5 V.DC



 Dark current vs. ambient temperature characteristics Reverse voltage : 5 V.DC



5. Relative photocurrent vs. reverse voltage characteristics

Light source : Fluorescent lamp, Brightness : 100 kr Ambient temperature : 25 °C 77 °F



Design and specifications are each subject to change without notice. Ask factory for the current technical specifications before purchase and/or use. Should a safety concern arise regarding this product, please be sure to contact us immediately.

 7. Switching time vs. resistive load characteristics Light source : White LED Power voltage : 5 V.DC Resistive load voltage : 2.5 V.DC Ambient temperature : 25 °C 77 °F



Dimensions

The CAD data of the products with a CAD Data mark can be downloaded from: http://industrial.panasonic.com/



General tolerance : $\pm 0.5 \ \pm 0.020$

unit : mm inch

Safety Precautions

Follow the instructions to prevent injuries and accidents.

- Avoid use beyond the specifications.
- Such use may generate abnormal heat, smoke and fire.
- Correctly connect terminals according to the pin arrangement in the specifications. Misconnection may invite unexpected malfunction, abnormal heat, smoke and fire.
- For safety-sensitive use, arrange appropriate protective circuits and protection devices.

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CAUTIONS FOR USE

■ Applying stress beyond absolute maximum rating When voltage and current values of each terminal exceed absolute maximum rating, overvoltage and overcurrent may deteriorate the internal element. In extreme cases, such excess may melt wires or damage the silicon P/N junction. Design the product not to exceed the absolute maximum rating even momentarily.

Deterioration and damage by static electricity discharge The phenomenon, deteriorating the internal element, is generally called electrostatic breakdown. It is caused by discharge of static electricity, arisen from multiple factors, to each terminal. Once unpacked, perform antistatic countermeasures and follow the instructions below.

- 1) Operators must wear antistatic cloths and human body grounding devices, and have the protective resistance of between 500 k Ω and 1 M $\Omega.$
- 2) Cover the surface of workbench by electroconductive metal plates and ground measuring instruments and jigs.
- Use the soldering iron which has a small leakage current or ground the soldering tip. (The soldering iron for a low voltage is recommended)
- 4) Ground the assembling equipment.
- 5) When packing printed-circuit boards and devices, avoid polymeric materials, which have electrification characteristics, such as expanded polystyrene and plastic.
- 6) When storing and transporting the sensor, choose the environment where static electricity is hardly generated (e.g., humidity between 45 and 60 %) and protect the product by using electroconductive packaging materials.

When the power is supplied, the current flowing into the sensor varies in order to stabilize the internal circuit.

Storage

The sensor is in the transparent resin package. Due to its sensitivity to humidity, the package is moisture-proof. When storing the sensor, follow the instructions below.

- 1) Promptly use after opening. (within a week, below 30 °C 86 °F/60 % R.H.)
- 2) Once unpacked, preserving in a moisture-proof manner, such as keeping in a moisture-proof bag with silica gels, is recommended for long-term storage. (use within 3 months)
- Extremely bad storage conditions may deteriorate solderability or characteristics, and defect the appearance. Recommended conditions of the storage place are below.
 - Temperature : 0 to 30 °C 32 to 86 °F
 - Humidity : Below 60% R.H. (Avoid freezing and dew condensation)
 - Atmosphere: Low-dust and free from noxious chemicals such as sulfurous acid gas
 - During soldering, when adding thermal stress in a moisture absorbing state, moisture evaporates, swells and generates stress to the internal package. To avoid swellings and cracks in the surface of the package, follow soldering conditions below.

Recommended soldering conditions <Through-hole type>



2) Keep the soldering part at a distance of 3 mm 0.118 inch or more from the root of the lead.

Mounting

- When various packages are on one circuit board, temperature rise of the lead largely depends on the package size. Keep temperature of the soldered terminals of the products below the previously mentioned specifications. Before use, check the performance with actual equipment.
- 2) If mounting conditions are beyond the specifications above, such use may decrease the resin strength, increase mismatching in the thermal expansion coefficient of each component material, generate cracks in the package and break the bonding wire. Please consult us before use.

Cleaning

For flux cleaning, immersion cleaning by ASAHIKLIN AK-225 is recommended. If using ultrasonic cleaning for unavoidable reasons, implementation conditions should not be beyond the specifications below. Before use, check and ensure that there is no defect.

- Frequency : 27 to 29 kHz
- Ultrasonic outlet : Below 0.25W/cm² *
- Cleaning time : Less than 30 sec.
- Cleaning solvent : ASAHIKLIN AK-225
- Others : In order to prevent the printed circuit board and elements from contacting with ultrasonic oscillator, clean the flux while the sensor is suspended in the solution.
- * Ultrasonic outlet per unit area (bottom area) of cleaning tank

Transportation

Excessive vibration during transport may deform the lead or damage the sensor. Carefully handle the exterior and interior boxes.

Avoid use in the highly-humid or dusty environment, the corrosive gas, an environment where organic solvent can be adhered.

Lead-forming and cuttings

- 1) Before soldering, perform lead forming at normal temperature.
- 2) When forming or cutting the lead, keep the spot at a distance of 3 mm 0.118 inch or more from the root of the lead.
- 3) When forming and cutting, fix the root of the lead.
- Avoid mounting which may cause stress on the root of the lead.

• The following shows the packaging format Through-hole type tape and reel (mm inch)

Туре	Tape dimensions					
		Item Feed hole	Symbol Po	Dimensions 12.7±0.3	Remarks	
		pitch Product interval pitch	P	0.500±0.012 12.7±1.0 0.500±0.039		
		Product distance	P ₂	6.35±1.3 0.250±0.051		
	Anode side \leftarrow \rightarrow Cathode side	Product bottom distance	н	20.5±1.0 0.807±0.039		
Light sensor NaPiCa Through-hole type AMS302T		Lead interval	F	2.54±0.5 0.100±0.020		
		Product slant	Δh	0±1.0 0±0.039		
		Product tilt	Δр	0±1.0 0±0.039		
		Tape width	W	18.0 ^{+1.0} 0.709 ^{+0.039} 0.709 ^{-0.020}		
		Holding tape width	W ₀	13.0±0.3 0.512±0.012		
		Feed hole position	W1	$\begin{array}{c}9.0\substack{+0.75\\-0.50}\\0.354\substack{+0.030\\-0.020}\end{array}$		
	Note : Zigzag tape style is used.	Holding tape distance	W ₂	0 to 0.5 0 to 0.020		
		Feed hole diameter	D ₀	3.8±0.2 0.150±0.008		
		Tape thickness	t	0.5±0.2 0.020±0.008	Included holding tape thickness	
		Defective product cutoff position	L	Max:11.0 Max:0.433		

Light Sensor NaPiCa terminology			
Term	Symbol	Explanation	
Reverse voltage	V _R	The applied voltage between the cathode and anode.	
Photocurrent	IL.	The current that flows between the cathode and anode when light is applied.	
Power dissipation	Р	The electric power loss that occurs between the cathode and anode.	
Operating temperature	T _{opr}	The workable ambient temperature range at which normal operation is possible under the condition of a prescribed allowable loss.	
Storage temperature	T _{stg}	The ambient temperature range at which the sensor can be left or stored without applying voltage.	
Peak sensitivity wavelength	$\lambda_{ m p}$	The wavelength of light at which sensitivity is at its maximum.	
Dark current	ID	The current between the cathode and anode when reverse voltage is applied during darkness.	
Rise time	tr	Time required for the output waveform to rise from 10 % to 90 % when light is applied.	
Fall time	t _f	Time required for the output waveform to fall from 90 % to 10 % when light is cut.	

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